74HC109; 74HCT109

Dual JK flip-flop with set and reset; positive-edge-trigger

Rev. 4 — 1 April 2020 Product data sheet

1. General description

The 74HC109; 74HCT109 is a dual positive edge triggered $J\overline{K}$ flip-flop featuring individual nJ and n \overline{K} inputs. It has clock (nCP) inputs, set (n $\overline{S}D$) and reset (n $\overline{R}D$) inputs and complementary nQ and n \overline{Q} outputs. The set and reset are asynchronous active LOW inputs and operate independently of the clock input. The nJ and n \overline{K} inputs control the state changes of the flip-flops as described in the mode select function table. The nJ and n \overline{K} inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation. The J \overline{K} design allows operation as a D-type flip-flop by connecting the nJ and n \overline{K} inputs together. Inputs include clamp diodes. It enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

2. Features and benefits

- · Input levels:
 - For 74HC109: CMOS level
 - For 74HCT109: TTL level
- J and K inputs for easy D-type flip-flop
- · Toggle flip-flop or "do nothing" mode
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

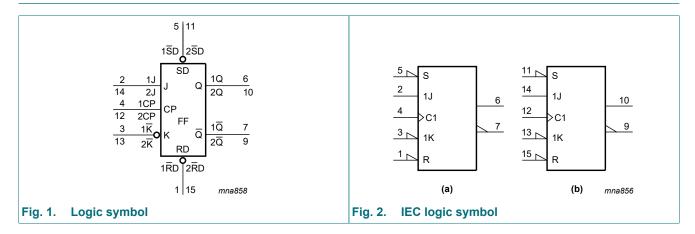
3. Ordering information

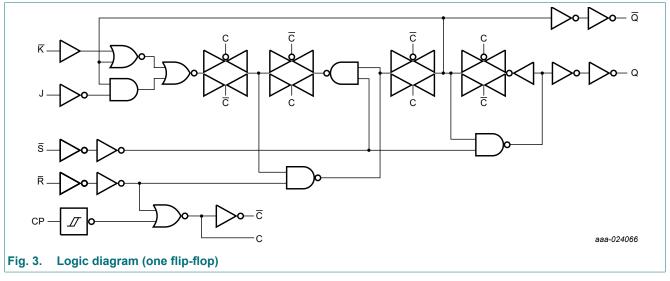
Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC109D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1
74HCT109D			body width 3.9 mm	
74HC109DB	-40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads;	SOT338-1
74HCT109DB			body width 5.3 mm	
74HCT109PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1



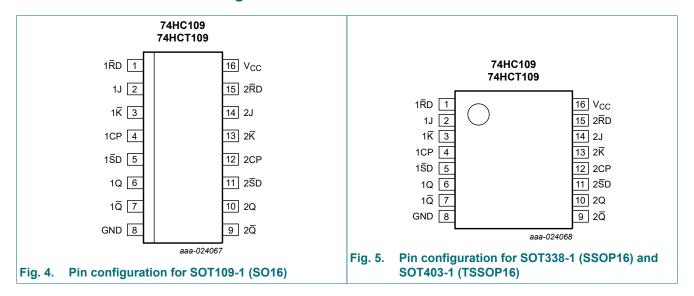
4. Functional diagram





5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1RD, 2RD	1, 15	asynchronous reset input (active LOW)
1J, 2J	2, 14	synchronous input
1K, 2K	3, 13	synchronous input
1CP, 2CP	4, 12	clock input (LOW-to-HIGH; edge-triggered)
1SD, 2SD	5, 11	asynchronous set input (active LOW)
1Q, 2Q	6, 10	true flip-flop output
1Q, 2Q	7, 9	complement flip-flop output
GND	8	ground (0 V)
V _{CC}	16	supply voltage

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6. Functional description

Table 3. Function selection

H = HIGH voltage level; h = HIGH voltage level one set-up time before the LOW-to-HIGH CP transition;

L = LOW voltage level; I = LOW voltage level one set-up time before the LOW-to-HIGH CP transition;

q = lower case letters indicate the state of the referenced output one set-up time before the LOW-to-HIGH CP transition;

 $X = don't care; \uparrow = LOW-to-HIGH CP transition$

Operating modes	Input					Output	
	n S D	nRD	nCP	nJ	n <mark>K</mark>	nQ	nQ
Asynchronous set	L	Н	Х	Х	Х	Н	L
Asynchronous reset	Н	L	X	Х	Х	L	Н
Undetermined	L	L	Х	Х	Х	Н	Н
Toggle	Н	Н	1	h	I	q	q
Load 0 (reset)	Н	Н	1	I	I	L	Н
Load 1 (set)	Н	Н	1	h	h	Н	L
Hold no change	Н	Н	1	I	h	q	q

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _O	output current	-0.5 V < V _O < V _{CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	+50	mA
I_{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[1]	-	500	mW

[1] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C. For SOT338-1 (SSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C. For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC109			7	Unit		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC10	9									
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I _O = -5.2 mA; V _{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 25 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT1	09									
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		I _O = 5.2 mA; V _{CC} = 5.5 V	-	0.15	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V								
		nJ, nK, nSD, nRD and nCP inputs	-	35	126	-	157.5	-	171.5	μA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Fig. 8.

Symbol	Parameter	Conditions		25 °C	25 °C		-40 °C to +85 °C		-40 °C to +125 °C	
			Min	Typ [1]	Max	Min	Max	Min	Max	
74HC109	9									
t _{pd}	propagation	nCP to nQ, nQ; see Fig. 6 [2]								
	delay	V _{CC} = 2.0 V	-	50	175	-	220	-	265	ns
		V _{CC} = 4.5 V	-	18	35	-	44	-	53	ns
		V _{CC} = 5 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	30	-	37	-	45	ns
t _{PLH}		nSD to nQ, see Fig. 7								
	propagation delay	V _{CC} = 2.0 V	-	30	120	-	150	-	180	ns
	delay	V _{CC} = 4.5 V	-	11	24	-	30	-	36	ns
		V _{CC} = 5 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	9	20	-	26	-	31	ns

Symbol	Parameter	Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	1
t _{PHL}	HIGH to LOW	nSD to nQ; see Fig. 7								
	propagation	V _{CC} = 2.0 V	-	41	155	-	195	-	235	ns
	delay	V _{CC} = 4.5 V	-	15	31	-	39	-	47	ns
		V _{CC} = 5 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	12	26	-	33	-	40	ns
t _{PHL}	HIGH to LOW	nRD to nQ; see Fig. 7								
	propagation	V _{CC} = 2.0 V	-	41	185	-	230	-	280	ns
	delay	V _{CC} = 4.5 V	-	15	37	-	46	-	56	ns
		V _{CC} = 5 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	12	31	-	39	-	48	ns
t _{PLH}	LOW to HIGH	nRD to nQ; see Fig. 7								
	propagation	V _{CC} = 2.0 V	-	39	170	-	215	-	255	ns
	delay	V _{CC} = 4.5 V	-	14	34	-	43	-	51	ns
		V _{CC} = 5 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	11	29	-	37	-	43	ns
t _t	transition time	$nQ, n\overline{Q}; see \underline{Fig. 6}$ [3]								
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _W	pulse width	nCP HIGH or LOW; see Fig. 6								
		V _{CC} = 2.0 V	80	19	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	7	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		nSD, nRD HIGH or LOW; see Fig. 7								
		V _{CC} = 2.0 V	80	14	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	5	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	4	-	17	-	20	-	ns
t _{rec}	recovery time	nSD, nRD to nCP; see Fig. 7								
		V _{CC} = 2.0 V	70	19	-	90	-	105	-	ns
		V _{CC} = 4.5 V	14	7	-	18	-	21	-	ns
		V _{CC} = 6.0 V	12	6	-	15	-	18	-	ns

Symbol	Parameter	Conditions		25 °C			°C to 5 °C	-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	
t _{su}	set-up time	nJ and nK to nCP; see Fig. 6								
		V _{CC} = 2.0 V	70	17	-	90	-	105	-	ns
		V _{CC} = 4.5 V	14	6	-	18	-	21	-	ns
		V _{CC} = 6.0 V	12	5	-	15	-	18	-	ns
t _h	hold time	nJ and nK to nCP; see Fig. 6								
		V _{CC} = 2.0 V	5	0	-	5	-	5	-	ns
		V _{CC} = 4.5 V	5	0	-	5	-	5	-	ns
		V _{CC} = 6.0 V	5	0	-	5	-	5	-	ns
f _{max}	maximum	nCP; see Fig. 6								
	frequency	V _{CC} = 2.0 V	6	22	-	5	-	4	-	MHz
		V _{CC} = 4.5 V	30	68	-	24	-	20	-	MHz
		V _{CC} = 5 V; C _L = 15 pF	-	75	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	35	81	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	C_L = 50 pF; f = 1 MHz; [4] V_I = GND to V_{CC}	-	20	-	-	-	-	-	pF
74HCT1	09									
t _{pd}	propagation	nCP to nQ, nQ;see Fig. 6 [2]								
	delay	V _{CC} = 4.5 V	-	20	35	-	44	-	53	ns
		V _{CC} = 5 V; C _L = 15 pF	-	17	-	-		-	-	ns
t _{PLH}	LOW to HIGH	nSD to nQ, see Fig. 7								
	propagation	V _{CC} = 4.5 V	-	13	26	-	33	-	39	ns
	delay	V _{CC} = 5 V; C _L = 15 pF	-	14	-	-	-	-	-	ns
t _{PHL}	HIGH to LOW	$n\overline{S}D$ to $n\overline{Q}$; see Fig. 7								
	propagation	V _{CC} = 4.5 V	-	19	35	-	44	-	53	ns
	delay	V _{CC} = 5 V; C _L = 15 pF	-	14	-	-	-	-	_	ns
t _{PHL}	HIGH to LOW	nRD to nQ; see Fig. 7								
	propagation	V _{CC} = 4.5 V	-	19	35	-	44	-	53	ns
	delay	V _{CC} = 5 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
t _{PLH}	LOW to HIGH	nRD to nQ; see Fig. 7								
	propagation	V _{CC} = 4.5 V	-	16	32	-	40	-	48	ns
	delay	V _{CC} = 5 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
t _t	transition time	nQ, $n\overline{Q}$; $V_{CC} = 4.5 \text{ V}$; [3] see Fig. 6	-	7	15	-	19	-	22	ns
t _W	pulse width	nCP HIGH or LOW; V _{CC} = 4.5 V; see <u>Fig. 6</u>	18	9	-	23	-	27	-	ns
		$n\overline{S}D$, $n\overline{R}D$ HIGH or LOW; $V_{CC} = 4.5 \text{ V}$; see Fig. 7	16	8	-	20	-	24	-	ns
t _{rec}	recovery time	$n\overline{S}D$, $n\overline{R}D$ to nCP ; $V_{CC} = 4.5 \text{ V}$; see Fig. 7	16	8	-	20	-	24	-	ns

Symbol	Parameter	Conditions		25 °C		-40 ° +85	C to		°C to 5 °C	Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	
t _{su}	set-up time	nJ and n \overline{K} to nCP; V _{CC} = 4.5 V; see Fig. 6	18	8	-	23	-	27	-	ns
t _h	hold time	nJ and n \overline{K} to nCP; V_{CC} = 4.5 V; see <u>Fig. 6</u>	3	-3	-	3	-	3	-	ns
f _{max}	maximum	nCP; see Fig. 6								
	frequency	V _{CC} = 4.5 V	27	55	-	22	-	18	-	MHz
		V _{CC} = 5 V; C _L = 15 pF	-	61	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance	$C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ [4] V _I = GND to V _{CC} - 1.5 V	-	22	-	-	-	-	-	pF

- All typical values are measured at T_{amb} = 25 °C.
- t_{pd} is the same as t_{PLH} and t_{PHL} .
- t_t is the same as t_{THL} and t_{TLH} . C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

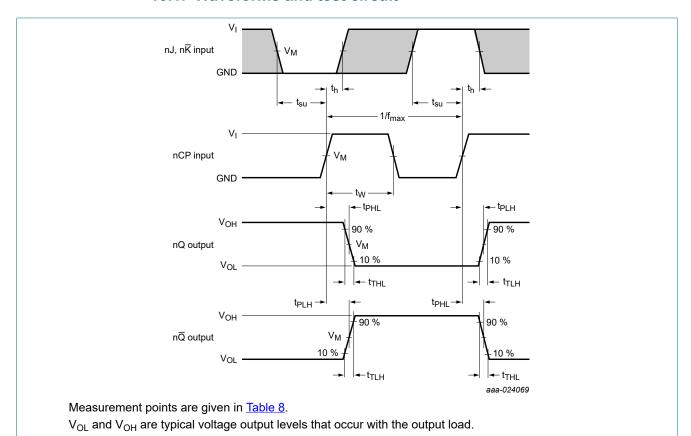
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of outputs.

10.1. Waveforms and test circuit



74HC_HCT109

Fig. 6.

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Clock propagation delays, output transition time, pulse width, set-up, hold times, and maximum

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frequency

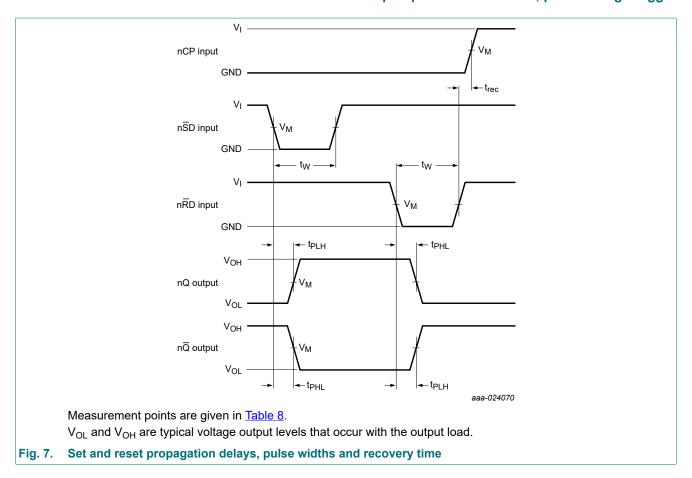
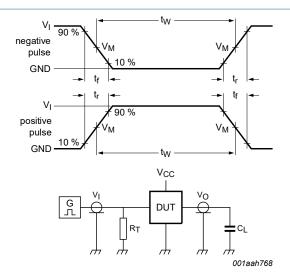


Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74HC109	0.5V _{CC}	0.5V _{CC}
74HCT109	1.3 V	1.3 V



Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 C_L = Load capacitance including jig and probe capacitance.

 R_L = Load resistance.

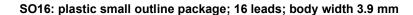
Fig. 8. Test circuit for measuring switching times

Table 9. Test data

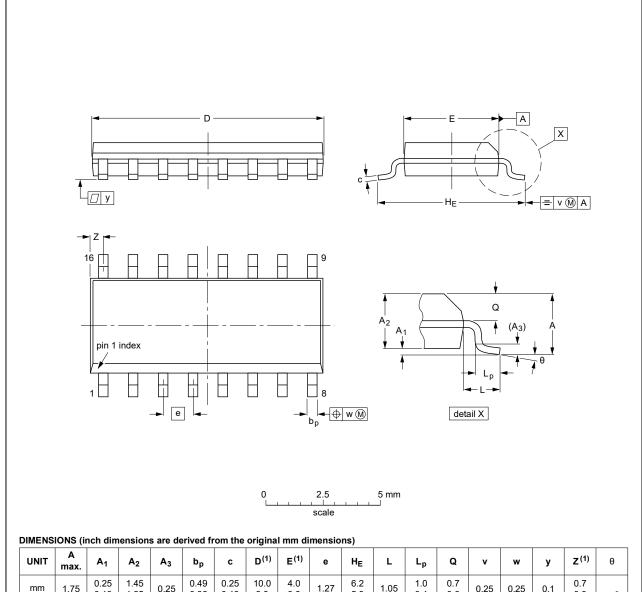
Туре	Input		Load	Test
	V _I	t _r , t _f	CL	
74HC109	V _{CC}	6 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}
74HCT109	3 V	6 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}

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11. Package outline



SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT109-1	076E07	MS-012				99-12-27 03-02-19

Fig. 9. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

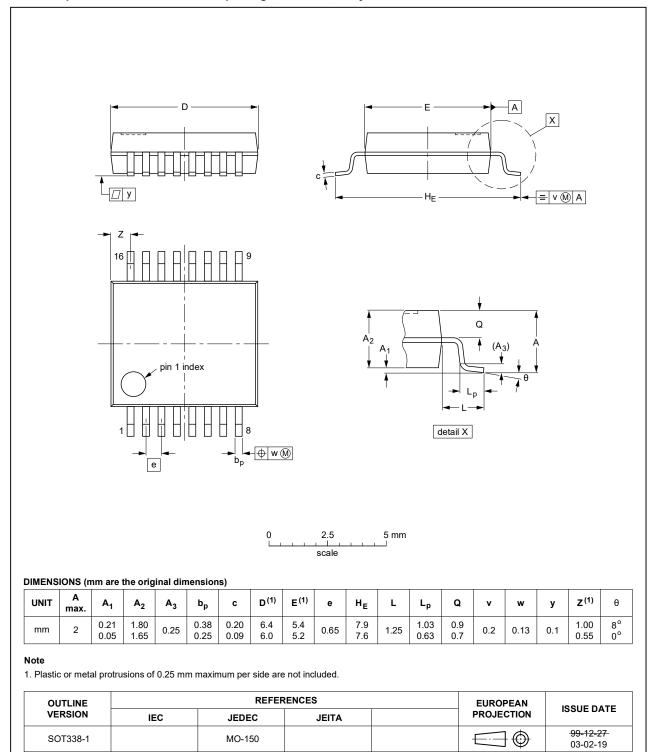


Fig. 10. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

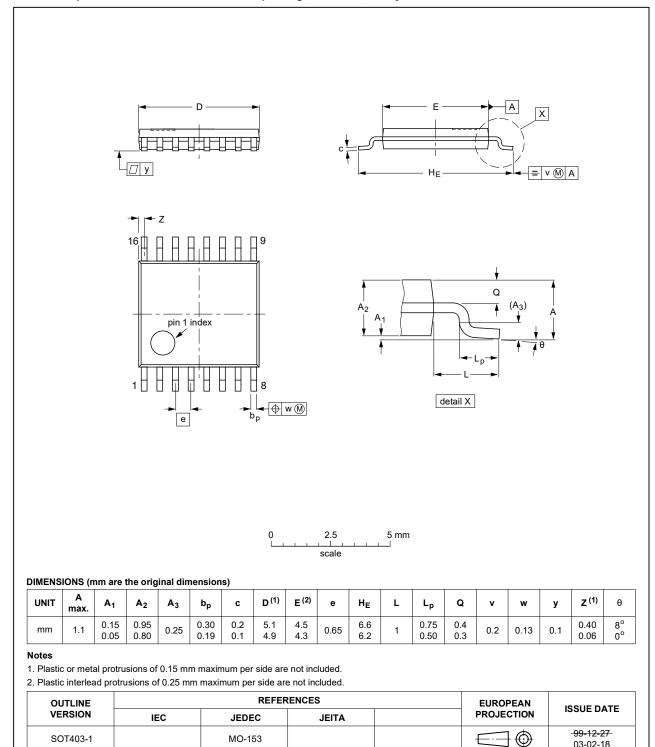


Fig. 11. Package outline SOT403-1 (TSSOP16)

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SOT403-1

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03-02-18

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT109 v.4	20200401	Product data sheet	-	74HC_HCT109 v.3
Modifications:	guidelines o Legal texts	of this data sheet has beer of Nexperia. have been adapted to the i rating values for P _{tot} total p	new company nar	ne where appropriate.
74HC_HCT109 v.3	20160801	Product data sheet	-	74HC_HCT109_CNV v.2
Modifications:	guidelines o	of this data sheet has beer of NXP Semiconductors. have been adapted to the i	_	
74HC_HCT109_CNV v.2	19971125	Product specification	-	-

Product data sheet

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14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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